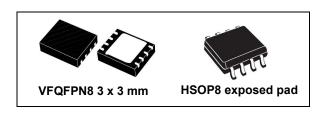


3 A step-down switching regulator

Datasheet - production data



Features

- · 3 A DC output current
- 2.9 V to 18 V input voltage
- Output voltage adjustable from 0.6 V
- 250 kHz switching frequency, programmable up to 1 MHz
- Internal soft-start and inhibit
- Low dropout operation: 100% duty cycle
- · Voltage feedforward
- Zero load current operation
- Overcurrent and thermal protection
- VFQFPN 3 x 3 -8L and HSOP8 package

Applications

 Consumer: STB, DVD, DVD recorder, car audio, LCD TV and monitors

- Industrial: PLD, PLA, FPGA, chargers
- Networking: XDSL, modems, DC-DC modules
- Computer: optical storage, hard disk drive, printers, audio/graphic cards
- LED driving

Description

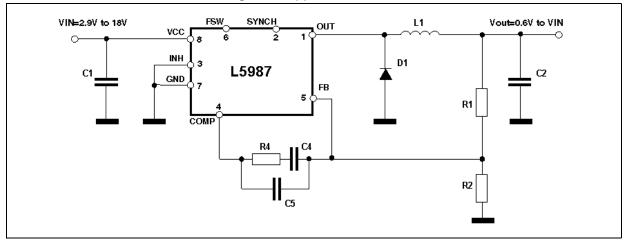
The L5987 is a step-down switching regulator with a 3.5 A (minimum) current limited embedded Power MOSFET, so it is able to deliver an up to 3 A current to the load depending on the application conditions.

The input voltage can range from 2.9 V to 18 V, while the output voltage can be set starting from 0.6 V to $V_{\rm IN}$. Having a minimum input voltage of 2.9 V, the device is suitable also for a 3.3 V bus.

Requiring a minimum set of external components, the device includes an internal 250 kHz switching frequency oscillator that can be externally adjusted up to 1 MHz.

The VFQFPN8 and the HSOP packages with an exposed pad allow reducing the R_{thJA} down to 60 °C/W and 40 °C/W respectively.

Figure 1. Application circuit



Contents L5987

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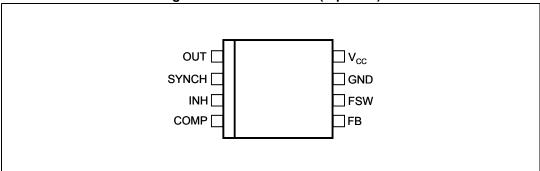
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Pin settings L5987

1 Pin settings

1.1 Pin connection

Figure 2. Pin connection (top view)



1.2 Pin description

Table 1. Pin description

No.	Туре	Description		
1	OUT	Regulator output		
2	SYNCH	Master/slave synchronization. When it is left floating, a signal with a phase shift of half a period with respect to the power turn-on is present at the pin. When connected to an external signal at a frequency higher than the internal one, then the device is synchronized by the external signal, with zero phase shift.		
		Connecting together the SYNCH pin of two devices, the one with higher frequency works as a master and the other one as a slave; so the two powers turn-on have a phase shift of half a period.		
3	INH	A logical signal (active high) disables the device. With INH higher than 1.9 V the device is OFF and with INH lower than 0.6 V the device is ON.		
4	COMP	Error amplifier output to be used for loop frequency compensation		
5	FB	Feedback input. Connecting the output voltage directly to this pin the output voltage is regulated at 0.6 V. To have higher regulated voltages an external resistor divider is required from the Vout to the FB pin.		
6	F _{SW}	The switching frequency can be increased connecting an external resistor from the FSW pin and ground. If this pin is left floating, the device works at its free-running frequency of 250 kHz.		
7	GND	Ground		
8	V _{CC}	Unregulated DC input voltage		

L5987 Maximum ratings

2 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
Vcc	Input voltage		20	
OUT	Output DC voltage		-0.3 to V _{CC}	
F _{SW} , COMP, SYNCH	CH Analog pin		-0.3 to 4	V
INH	Inhibit pin		-0.3 to V _{CC}	
FB	Feedback voltage		-0.3 to 1.5	
D	Davier dissination at T. 400 °C	VFQFPN	1.5.	W
P _{TOT}	Power dissipation at T _A < 60 °C	HSOP	2	
T _J	Junction temperature range		-40 to 150	°C
T _{stg}	Storage temperature range		-55 to 150	°C

3 Thermal data

Table 3. Thermal data

Symbol	Parameter		Value	Unit
В	Maximum thermal registance junction ambient(1)	VFQFPN	60	°C/W
K _{thJA}	Maximum thermal resistance junction ambient ⁽¹⁾	HSOP	40	C/VV

^{1.} Package mounted on demonstration board.

Electrical characteristics L5987

4 Electrical characteristics

 T_J = 25 °C, V_{CC} = 12 V, unless otherwise specified.

Table 4. Electrical characteristics

Symbol Parameter Test condition		Values		
	Min.	Тур.	Max.	Unit
V _{CC} Operating input voltage range (1)	2.9		18	
V _{CCON} Turn-on V _{CC} threshold (1)			2.9	V
V _{CCHYS} V _{CC} UVLO hysteresis (1)	0.175		0.3	
R _{DS(on)} MOSFET on resistance		140	170	mΩ
R _{DS(on)} MOSFET on resistance (1)		140	220	1115.2
I _{LIM} Maximum limiting current	3.5	4.0	4.4	Α
Oscillator				
Contabination for many	225	250	275	1.11=
F _{SW} Switching frequency (1)	220		265	kHz
V _{FSW} FSW pin voltage		1.262		V
D Duty cycle	0		100	%
F_{ADJ} Adjustable switching frequency $R_{FSW} = 33 \text{ k}\Omega$		1000		kHz
Dynamic characteristics				
V_{FB} Feedback voltage 2.9 V < V_{CC} < 18 $V^{(1)}$	0.593	0.6	0.607	V
DC characteristics				
I _Q Quiescent current Duty cycle = 0, V _{FB} = 0.8 V			2.4	mA
I _{QST-BY} Total standby quiescent current		20	30	μΑ
Inhibit				
Device ON level			0.6	V
INH threshold voltage Device OFF level	1.9			V
INH current INH = 0		7.5	10	μА
Soft-start	•			
FSW pin floating	7.4	8.2	9.1	ma
T_{SS} Soft-start duration $F_{SW} = 1 \text{ MHz}, R_{FSW} = 33 \text{ k}\Omega$		2		ms

Table 4. Electrical characteristics (continued)

•			Values				
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
Error ampli	ifier						
V_{CH}	High level output voltage	V _{FB} < 0.6 V	3			V	
V _{CL}	Low level output voltage	V _{FB} > 0.6 V			0.1	V	
I _{FB}	Bias source current	V _{FB} = 0 V to 0.8 V		1		μΑ	
I _{O SOURCE}	Source COMP pin	V _{FB} = 0.5 V, V _{COMP} = 1 V		20		mA	
I _{O SINK}	Sink COMP pin	V _{FB} = 0.7 V, V _{COMP} = 1 V		25		mA	
G _V	Open loop voltage gain	(2)		100		dB	
Synchroniz	zation function						
	High input voltage		2		3.3	V	
	Low input voltage				1	V	
	Slave sink current	V _{SYNCH} = 2.9 V		0.7	0.9	mA	
	Master output amplitude	I _{SOURCE} = 4.5 mA	2.0			V	
	Output pulse width	SYNCH floating		110		20	
	Input pulse width		70			ns	
Protection			•				
I _{FBDISC}	FB disconnection source current			1		μА	
т	Thermal shutdown			150		°C	
T _{SHDN}	Hysteresis			30			

^{1.} Specification referred to T_J from -40 to +125 °C. Specification in the -40 to +125 °C temperature range are assured by design, characterization and statistical correlation.

^{2.} Guaranteed by design.

5 Functional description

The L5987 device is based on a "voltage mode", constant frequency control. The output voltage V_{OUT} is sensed by the feedback pin (FB) compared to an internal reference (0.6 V) providing an error signal that, compared to a fixed frequency sawtooth, controls the ON and OFF time of the power switch.

The main internal blocks are shown in the block diagram in *Figure 3*. They are:

- A fully integrated oscillator that provides sawtooth to modulate the duty cycle and the synchronization signal. Its switching frequency can be adjusted by an external resistor. The voltage and frequency feedforward are implemented.
- The soft-start circuitry to limit inrush current during the startup phase.
- The voltage mode error amplifier.
- The pulse width modulator and the relative logic circuitry necessary to drive the internal power switch.
- The high-side driver for an embedded P-channel Power MOSFET switch.
- The peak current limit sensing block, to handle overload and short-circuit conditions.
- A voltage regulator and internal reference. It supplies internal circuitry and provides a fixed internal reference.
- A voltage monitor circuitry (UVLO) that checks the input and internal voltages.
- A thermal shutdown block, to prevent thermal runaway.

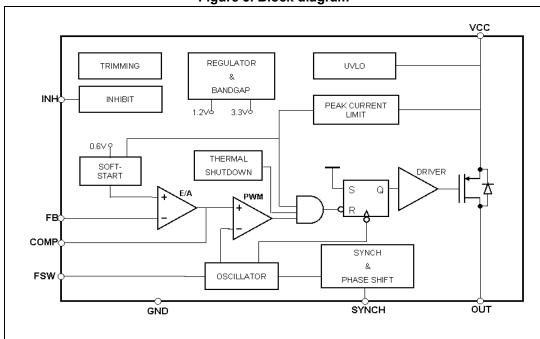


Figure 3. Block diagram

5.1 Oscillator and synchronization

Figure 4 shows the block diagram of the oscillator circuit. The internal oscillator provides a constant frequency clock. Its frequency depends on the resistor externally connected to the FSW pin. In case the FSW pin is left floating, the frequency is 250 kHz; it can be increased as shown in Figure 6 by an external resistor connected to ground.

To improve the line transient performance, keeping the PWM gain constant versus the input voltage, the voltage feedforward is implemented by changing the slope of the sawtooth according to the input voltage change (see *Figure 5*.a).

The slope of the sawtooth also changes if the oscillator frequency is increased by the external resistor. In this way a frequency feedforward is implemented (*Figure 5.b*) in order to keep the PWM gain constant versus the switching frequency (see *Section 6.4 on page 20* for PWM gain expression).

On the SYNCH pin the synchronization signal is generated. This signal has a phase shift of 180° with respect to the clock. This delay is useful when two devices are synchronized connecting the SYNCH pin together. When SYNCH pins are connected, the device with a higher oscillator frequency works as a master, so the slave device switches at the frequency of the master but with a delay of half a period. This minimizes the RMS current flowing through the input capacitor (see the L5988D datasheet).

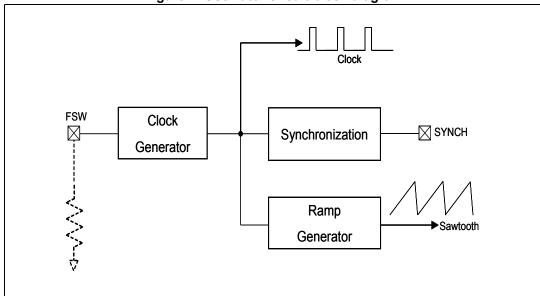


Figure 4. Oscillator circuit block diagram

The device can be synchronized to work at a higher frequency feeding an external clock signal. The synchronization changes the sawtooth amplitude, changing the PWM gain (*Figure 5.c*). This changing has to be taken into account when the loop stability is studied. To minimize the change of the PWM gain, the free-running frequency should be set (with a resistor on the FSW pin) only slightly lower than the external clock frequency. This preadjusting of the frequency will change the sawtooth slope in order to get negligible the truncation of sawtooth, due to the external synchronization.



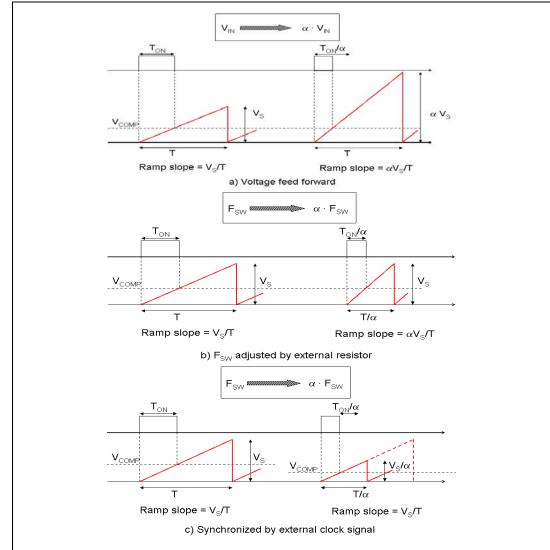
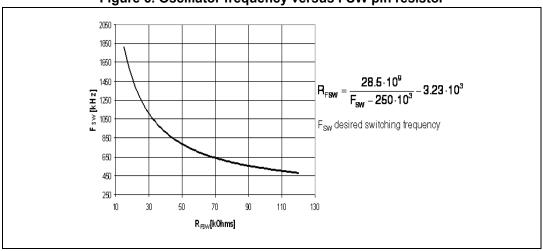


Figure 5. Sawtooth: voltage and frequency feedforward; external synchronization





5.2 Soft-start

The soft-start is essential to assure a correct and safe startup of the step-down converter. It avoids inrush current surge and makes the output voltage increase monotonically.

The soft-start is performed by a staircase ramp on the non-inverting input (V_{REF}) of the error amplifier. So the output voltage slew rate is:

Equation 1

$$SR_{OUT} = SR_{VREF} \cdot \left(1 + \frac{R1}{R2}\right)$$

where SR_{VREF} is the slew rate of the non-inverting input, while R1 and R2 is the resistor divider to regulate the output voltage (see *Figure 7*). The soft-start staircase consists of 64 steps of 9.5 mV each one, from 0 V to 0.6 V. The time base of one step is of 32 clock cycles. So the soft-start time and then the output voltage slew rate depend on the switching frequency.

V_{QUT} FB E/A COMP V_{QUT} FB V_{REF} V_{QUT} V_{QUT} PB V_{REF} V_{REF}

Figure 7. Soft-start scheme

Soft-start time results:

Equation 2

$$SS_{TIME} = \frac{32 \cdot 64}{Fsw}$$

For example with a switching frequency of 250 kHz the SS_{TIME} is 8 ms.

5.3 Error amplifier and compensation

The error amplifier (E/A) provides the error signal to be compared with the sawtooth to perform the pulse width modulation. Its non-inverting input is internally connected to a 0.6 V voltage reference, while its inverting input (FB) and output (COMP) are externally available for feedback and frequency compensation. In this device the error amplifier is a voltage mode operational amplifier so with the high DC gain and low output impedance.

The uncompensated error amplifier characteristics are the following:

Table 5. Uncompensated error amplifier characteristics

Parameter	Value
Low frequency gain	100 dB
GBWP	4.5 MHz
Slew rate	7 V/μs
Output voltage swing	0 to 3.3 V
Maximum source/sink current	25 mA/40 mA

In continuous conduction mode (CCM), the transfer function of the power section has two poles due to the LC filter and one zero due to the ESR of the output capacitor. Different kinds of compensation networks can be used depending on the ESR value of the output capacitor. In case the zero introduced by the output capacitor helps to compensate the double pole of the LC filter, a type II compensation network can be used. Otherwise, a type III compensation network has to be used (see *Section 6.4 on page 20* for details about the compensation network selection).

Anyway the methodology to compensate the loop is to introduce zeros to obtain a safe phase margin.



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5.4 Overcurrent protection

The L5987 device implements the overcurrent protection sensing current flowing through the Power MOSFET. Due to the noise created by the switching activity of the Power MOSFET, the current sensing is disabled during the initial phase of the conduction time. This avoids an erroneous detection of a fault condition. This interval is generally known as "masking time" or "blanking time". The masking time is about 200 ns.

When the overcurrent is detected, two different behaviors are possible depending on the operating condition.

- Output voltage in regulation. When the overcurrent is sensed, the Power MOSFET is switched off and the internal reference (V_{REF}), that biases the non-inverting input of the error amplifier, is set to zero and kept in this condition for a soft-start time (T_{SS}, 2048 clock cycles). After this time, a new soft-start phase takes place and the internal reference begins ramping (see *Figure 8.a*).
- Soft-start phase. If the overcurrent limit is reached, the Power MOSFET is turned off implementing the pulse by pulse overcurrent protection. During the soft-start phase, under overcurrent condition, the device can skip pulses in order to keep the output current constant and equal to the current limit. If, at the end of the "masking time", the current is higher than the overcurrent threshold, the Power MOSFET is turned off and it will skip one pulse. If, at the next switching on at the end of the "masking time", the current is still higher than the threshold, the device will skip two pulses. This mechanism is repeated and the device can skip up to seven pulses. While, if at the end of the "masking time" the current is lower than the overcurrent threshold, the number of skipped cycles is decreased by one unit. At the end of soft-start phase the output voltage is in regulation and if the overcurrent persists, the behavior explained above takes place.(see Figure 8.b).

So the overcurrent protection can be summarized as a "hiccup" intervention when the output is in regulation and a constant current during the soft-start phase. If the output is shorted to ground when the output voltage is on regulation, the overcurrent is triggered and the device starts cycling with a period of 2048 clock cycles between the "hiccup" (Power MOSFET off and no current to the load) and "constant current" with very short ON time and with reduced switching frequency (up to one eighth of normal switching frequency). See *Figure 33 on page 357* for short-circuit behavior.



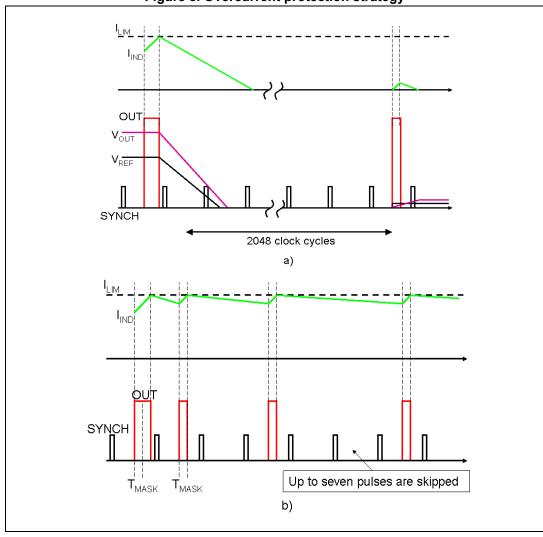


Figure 8. Overcurrent protection strategy

5.5 Inhibit function

The inhibit feature allows to put the device into standby mode . With the INH pin higher than 1.9 V, the device is disabled and the power consumption is reduced to less than 30 $\mu A.$ With the INH pin lower than 0.6 V, the device is enabled. If the INH pin is left floating, an internal pull-up ensures that the voltage at the pin reaches the inhibit threshold and the device is disabled. The pin is also V_{CC} compatible.

5.6 Hysteretic thermal shutdown

The thermal shutdown block generates a signal, that turns off the power stage, if the junction temperature goes above 150 °C. Once the junction temperature goes back to about 130 °C, the device restarts in normal operation. The sensing element is very close to the PDMOS area, so ensuring an accurate and fast temperature detection.

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5.7 Maximum DC output current L5987A (HSOP8)

The L5987A device can manage DC output currents up to 3 A and the rated RMS current of its internal power switch is 3 A. So the L5987A can deliver 3 A with 100% of duty cycle.

5.8 Maximum DC output current L5987 (VFQFPN)

The L5987 can manage DC output currents up to 3 A. However the rated RMS current of its internal power switch is 2.5 A.

Since the current flows through the integrated power element only during the on time, the RMS value is given by:

Equation 3

$$I_{RMS} = I_O \cdot \sqrt{D}$$

Where D is the duty cycle (V_O / V_{IN}).

Considering $I_0 = 3$ A, the maximum duty cycle that can be managed is:

Equation 4

$$D = \frac{I_{RMS}^2}{I_{O}^2} = 69\%$$

In *Figure 9* the maximum DC output current is reported as a function of the duty cycle. For duty cycles lower than 69% the RMS current does not limit the maximum DC output current of 3 A. For duty cycles higher than the 69% the maximum DC output current is limited by the RMS current to:

Equation 5

$$I_{O, MAX} = \frac{2.5}{\sqrt{D}}$$
 [A] if D \ge 69%

In order to have a more accurate calculation of the maximum DC output current, the complete expression for the duty cycle can be adopted, considering the voltage drop across the Power MOSFET, the series resistance of the inductor and the forward voltage of the rectification diode. The duty cycle results:

Equation 6

$$D = \frac{V_{OUT} + V_F + DCR \cdot I_O}{V_{IN} + V_F - R_{DSON} \cdot I_O}$$

where I_O is the desired DC output current.

For example with V_{IN} = 5 V, V_{OUT} = 3.3 V, I_{O} = 2.6 A, $R_{DS(on)}$ = 220 m Ω , V_{F} = 0.35 V and DCR = 30 m Ω , the duty results D = 78%, so according to *Equation 5* the maximum DC output current is 2.83 A, which is higher than desired current.

With V_{IN} = 3.3 V, V_{OUT} = 1.8 V, I_O = 2.7 A, R_{DS(on)} = 220 m Ω , V_F = 0.35 V and DCR = 30 m Ω , the duty is D = 73%, so the maximum DC output current results 2.926 A, higher than the desired current.



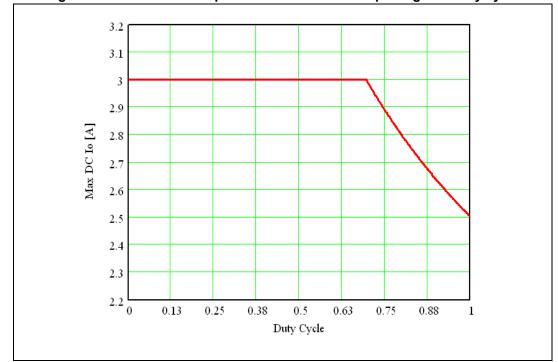


Figure 9. Maximum DC output current for VFQFPN8 package vs. duty cycle

Note:

For duty cycles lower than 69%, the RMS current does not limit the maximum DC output current of 3 A. For duty cycles higher than the 69% the maximum DC output current is limited by the RMS current (see Equation 5).



6 Application information

6.1 Input capacitor selection

The capacitor connected to the input has to be capable to support the maximum input operating voltage and the maximum RMS input current required by the device. The input capacitor is a subject to a pulsed current, the RMS value of which is dissipated over its ESR, affecting the overall system efficiency.

So the input capacitor must have an RMS current rating higher than the maximum RMS input current and an ESR value compliant with the expected efficiency.

The maximum RMS input current flowing through the capacitor can be calculated as:

Equation 7

$$I_{RMS} = I_O \cdot \sqrt{D - \frac{2 \cdot D^2}{\eta} + \frac{D^2}{\eta^2}}$$

Where I_O is the maximum DC output current, D is the duty cycle, η is the efficiency. Considering $\eta = 1$, this function has a maximum at D = 0.5 and it is equal to $I_O/2$.

In a specific application the range of possible duty cycles has to be considered in order to find out the maximum RMS input current. The maximum and minimum duty cycles can be calculated as:

Equation 8

$$D_{MAX} = \frac{V_{OUT} + V_F}{V_{INMIN} - V_{SW}}$$

and

Equation 9

$$\mathsf{D}_{\mathsf{MIN}} = \frac{\mathsf{V}_{\mathsf{OUT}} + \mathsf{V}_{\mathsf{F}}}{\mathsf{V}_{\mathsf{INMAX}} - \mathsf{V}_{\mathsf{SW}}}$$

Where V_F is the forward voltage on the freewheeling diode and V_{SW} is voltage drop across the internal PDMOS.

In Table 6 some multi-layer ceramic capacitors suitable for this device are reported:

Table 6. Input MLCC capacitors

Manufacturer	Series	Cap value (μF)	Rated voltage (V)
MURATA	GRM31	10	25
MORATA	GRM55	10	25
TDK	C3225	10	25



6.2 Inductor selection

The inductance value fixes the current ripple flowing through the output capacitor. So the minimum inductance value, in order to have the expected current ripple, has to be selected. The rule to fix the current ripple value is to have a ripple at 20% - 40% of the output current.

In the continuous current mode (CCM), the inductance value can be calculated by the following equation:

Equation 10

$$\Delta I_L = \frac{V_{IN} - V_{OUT}}{I} \cdot T_{ON} = \frac{V_{OUT} + V_F}{I} \cdot T_{OFF}$$

Where T_{ON} is the conduction time of the internal high-side switch and T_{OFF} is the conduction time of the external diode [in CCM, F_{SW} = 1 / (T_{ON} + T_{OFF})]. The maximum current ripple, at fixed V_{OUT} , is obtained at maximum T_{OFF} that is at minimum duty cycle (see Section 6.1 to calculate minimum duty). So fixing ΔI_L = 20% to 30% of the maximum output current, the minimum inductance value can be calculated:

Equation 11

$$L_{MIN} = \frac{V_{OUT} + V_F}{\Delta I_{MAX}} \cdot \frac{1 - D_{MIN}}{F_{SW}}$$

where F_{SW} is the switching frequency, 1 / ($T_{ON} + T_{OFF}$).

For example for V_{OUT} = 3.3 V, V_{IN} = 12 V, I_O = 3 A and F_{SW} = 250 kHz the minimum inductance value to have ΔI_L = 30% of I_O is about 10 μ H.

The peak current through the inductor is given by:

Equation 12

$$I_{L, PK} = I_O + \frac{\Delta I_L}{2}$$

So if the inductor value decreases, the peak current (that has to be lower than the current limit of the device) increases. The higher is the inductor value, the higher is the average output current that can be delivered, without reaching the current limit.

In Table 7 some inductor part numbers are listed.

Table 7. Inductors

Manufacturer	Series	Inductor value (μH)	Saturation current (A)
Coilcraft	MSS1038	3.8 to 10	3.9 to 6.5
Colletait	MSS1048	12 to 22	3.84 to 5.34
Wurth	PD Type L	8.2 to 15	3.75 to 6.25
vvartii	PD Type M	2.2 to 4.7	4 to 6
SUMIDA	CDRH6D226/HP	1.5 to 3.3	3.6 to 5.2
SOIVIIDA	CDR10D48MN	6.6 to 12	4.1 to 5.7



6.3 Output capacitor selection

The current in the capacitor has a triangular waveform which generates a voltage ripple across it. This ripple is due to the capacitive component (charge or discharge of the output capacitor) and the resistive component (due to the voltage drop across its ESR). So the output capacitor has to be selected in order to have a voltage ripple compliant with the application requirements.

The amount of the voltage ripple can be calculated starting from the current ripple obtained by the inductor selection.

Equation 13

$$\Delta V_{OUT} = ESR \cdot \Delta I_{MAX} + \frac{\Delta I_{MAX}}{8 \cdot C_{OUT} \cdot f_{SW}}$$

Usually the resistive component of the ripple is much higher than the capacitive one, if the output capacitor adopted is not a multi-layer ceramic capacitor (MLCC) with very low ESR value.

The output capacitor is important also for loop stability: it fixes the double LC filter pole and the zero due to its ESR. In Section 6.4 it will be illustrated how to consider its effect in the system stability.

For example: with V_{OUT} = 3.3 V, V_{IN} = 12 V, ΔI_L = 0.9 A (resulting by the inductor value), in order to have a ΔV_{OUT} = 0.01· V_{OUT} , if the multi-layer ceramic capacitors are adopted, 13 μF are needed and the ESR effect on the output voltage ripple can be neglected. In case of not negligible ESR (electrolytic or tantalum capacitors), the capacitor is chosen taking into account its ESR value. So in case of 330 μF with ESR = 30 m Ω , the resistive component of the drop dominates and the voltage ripple is 27 mV.

The output capacitor is also important to sustain the output voltage when a load transient with high slew rate is required by the load. When the load transient slew rate exceeds the system bandwidth the output capacitor provides the current to the load. So if the high slew rate load transient is required by the application the output capacitor and system bandwidth have to be chosen in order to sustain the load transient.

In Table 8 some capacitor series are listed.

Table 8. Output capacitors

Manufacturer	Series	Cap value (μF)	Rated voltage (V)	ESR (m Ω)
MURATA	GRM32	22 to 100	6.3 to 25	< 5
WORATA	GRM31	10 to 47	6.3 to 25	< 5
Panasonic	ECJ	10 to 22	6.3	< 5
Panasonic	EEFCD	10 to 68	6.3	15 to 55
SANYO	TPA/B/C	100 to 470	4 to 16	40 to 80
TDK	C3225	22 to 100	6.3	< 5



6.4 Compensation network

The compensation network has to assure stability and a good dynamic performance. The loop of the L5987 is based on the voltage mode control. The error amplifier is a voltage operational amplifier with high bandwidth. So selecting the compensation network the E/A will be considered as ideal, that is, its bandwidth is much larger than the system one.

The transfer functions of the PWM modulator and the output LC filter are studied (see *Figure 10*). The transfer function of the PWM modulator, from the error amplifier output (COMP pin) to the OUT pin, results:

Equation 14

$$G_{PW0} \, = \, \frac{V_{IN}}{V_s}$$

where V_S is the sawtooth amplitude. As seen in Section 5.1 on page 9, the voltage feedforward generates a sawtooth amplitude directly proportional to the input voltage, that is:

Equation 15

$$V_S = K \cdot V_{IN}$$

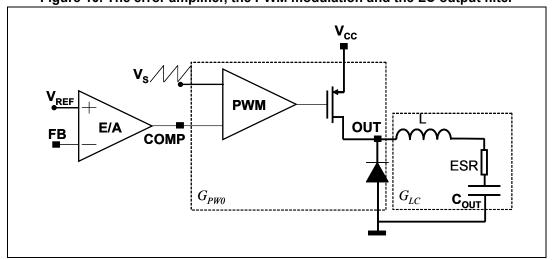
In this way the PWM modulator gain results constant and equals to:

Equation 16

$$G_{PW0} = \frac{V_{IN}}{V_s} = \frac{1}{K} = 9$$

The synchronization of the device with an external clock provided trough the SYNCH pin can modify the PWM modulator gain (see *Section 5.1* to understand how this gain changes and how to keep it constant in spite of the external synchronization).

Figure 10. The error amplifier, the PWM modulation and the LC output filter



The transfer function on the LC filter is given by:

Equation 17

$$G_{LC}(s) = \frac{1 + \frac{s}{2\pi \cdot f_{zESR}}}{1 + \frac{s}{2\pi \cdot Q \cdot f_{LC}} + \left(\frac{s}{2\pi \cdot f_{LC}}\right)^2}$$

where:

Equation 18

$$f_{LC} = \frac{1}{2\pi \cdot \sqrt{L \cdot C_{OUT}} \cdot \sqrt{1 + \frac{ESR}{R_{OUT}}}}, \qquad f_{zESR} = \frac{1}{2\pi \cdot ESR \cdot C_{OUT}}$$

Equation 19

$$\label{eq:Q} Q \, = \, \frac{\sqrt{R_{OUT} \cdot L \cdot C_{OUT} \cdot (R_{OUT} + ESR)}}{L + C_{OUT} \cdot R_{OUT} \cdot ESR}, \qquad \quad R_{OUT} = \frac{V_{OUT}}{I_{OUT}}$$

As seen in *Section 5.3 on page 12* two different kinds of network can compensate the loop. In the two following paragraph the guidelines to select the type II and type III compensation network are illustrated.

6.4.1 Type III compensation network

The methodology to stabilize the loop consists of placing two zeros to compensate the effect of the LC double pole, so increasing phase margin; then to place one pole in the origin to minimize the DC error on regulated output voltage; finally to place other poles far away the zero dB frequency.

If the equivalent series resistance (ESR) of the output capacitor introduces a zero with a frequency higher than the desired bandwidth (that is: $2\pi * ESR * C_{OUT} < 1$ / BW), the type III compensation network is needed. Multi-layer ceramic capacitors (MLCC) have very low ESR (< 1 m Ω), with very high frequency zero, so type III network is adopted to compensate the loop.

In *Figure 11* the type III compensation network is shown. This network introduces two zeros (f_{Z1}, f_{Z2}) and three poles (f_{P0}, f_{P1}, f_{P2}) . They are expressed as:

Equation 20

$$f_{Z1} = \frac{1}{2\pi \cdot C_3 \cdot (R_1 + R_3)}, \qquad f_{Z2} = \frac{1}{2\pi \cdot R_4 \cdot C_4}$$

Equation 21

$$f_{P0} = 0, \qquad f_{P1} = \frac{1}{2\pi \cdot R_3 \cdot C_3}, \qquad f_{P2} = \frac{1}{2\pi \cdot R_4 \cdot \frac{C_4 \cdot C_5}{C_4 + C_5}}$$



Vout R3 C3 FB E/A C4

Figure 11. Type III compensation network

In Figure 12 the Bode diagram of the PWM and LC filter transfer function [$G_{PW0} \cdot G_{LC}(f)$] and the open loop gain [$G_{LOOP}(f) = G_{PW0} \cdot G_{LC}(f) \cdot G_{TYPEIII}(f)$] are drawn.

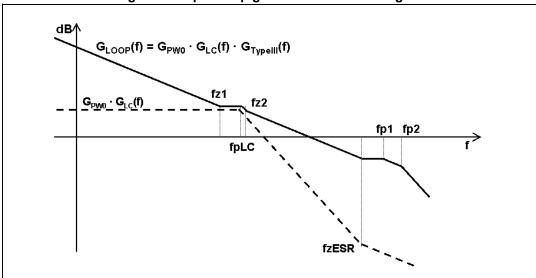


Figure 12. Open loop gain: module Bode diagram

The guidelines for positioning the poles and the zeroes and for calculating the component values can be summarized as follows:

- 1. Choose a value for R_1 , usually between 1 $k\Omega$ and 5 $k\Omega$.
- 2. Choose a gain (R_4/R_1) in order to have the required bandwidth (BW), that means:

Equation 22

$$R_4 = \frac{BW \cdot K}{f_{LC}} \cdot R_1$$

where K is the feedforward constant and 1 / K is equal to 9.

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3. Calculate C_4 by placing the zero at 50% of the output filter double pole frequency (f_{LC}):

Equation 23

$$C_4 = \frac{1}{\pi \cdot R_4 \cdot f_{1,C}}$$

Calculate C₅ by placing the second pole at four times the system bandwidth (BW):

Equation 24

$$C_5 = \frac{C_4}{2\pi \cdot R_4 \cdot C_4 \cdot 4 \cdot BW - 1}$$

5. Set also the first pole at four times the system bandwidth and also the second zero at the output filter double pole:

Equation 25

$$R_3 = \frac{R_1}{\frac{4 \cdot BW}{f_{1,C}} - 1},$$
 $C_3 = \frac{1}{2\pi \cdot R_3 \cdot 4 \cdot BW}$

The suggested maximum system bandwidth is equal to the switching frequency divided by 3.5 ($F_{SW}/3.5$), anyway lower than 100 kHz if the F_{SW} is set higher than 500 kHz.

For example: with V_{OUT} = 3.3 V, V_{IN} = 12 V, I_O = 3 A, L = 10 μ H, C_{OUT} = 22 μ F, ESR < 1 m Ω , the type III compensation network is:

$${\rm R_1 = 4.99 k\Omega}, \quad {\rm R_2 = 1.1 k\Omega}, \quad {\rm R_3 = 220 \Omega}, \quad {\rm R_4 = 3.3 k\Omega}, \quad {\rm C_3 = 3.3 nF}, \quad {\rm C_4 = 10 nF}, \quad {\rm C_5 = 180 pF}$$



In *Figure 13* is shown the module and phase of the open loop gain. The bandwidth is about 71 kHz and the phase margin is 46°.

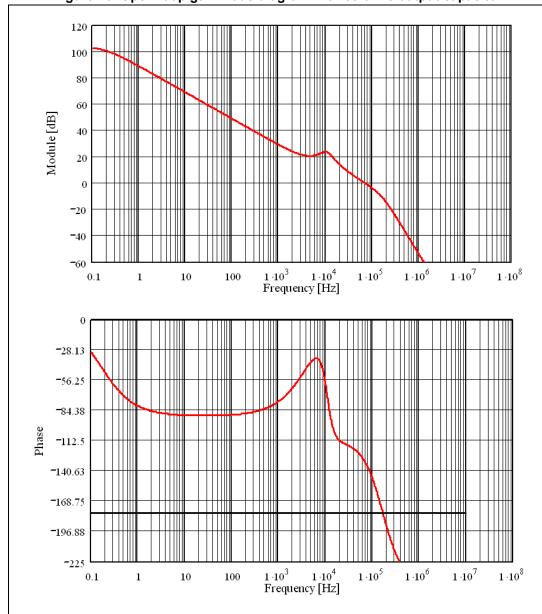


Figure 13. Open loop gain Bode diagram with ceramic output capacitor



6.4.2 Type II compensation network

If the equivalent series resistance (ESR) of the output capacitor introduces a zero with a frequency lower than the desired bandwidth (that is: $2\pi * ESR * C_{OUT} > 1$ / BW), this zero helps stabilize the loop. Electrolytic capacitors show not negligible ESR (> 30 m Ω), so with this kind of the output capacitor, the type II network combined with the zero of the ESR allows stabilizing the loop.

In Figure 14 the type II network is shown.

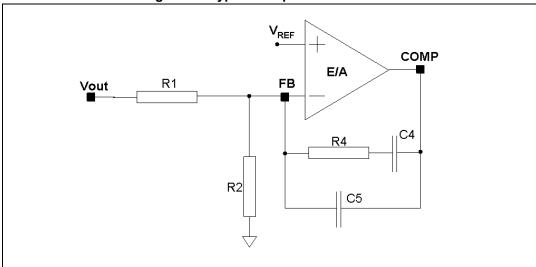


Figure 14. Type II compensation network

The singularities of the network are:

Equation 26

$$f_{Z1} = \frac{1}{2\pi \cdot R_4 \cdot C_4}, \qquad f_{P0} = 0, \qquad f_{P1} = \frac{1}{2\pi \cdot R_4 \cdot \frac{C_4 \cdot C_5}{C_4 + C_5}}$$



In Figure 15 the Bode diagram of the PWM and LC filter transfer function [$G_{PW0} \cdot G_{LC}(f)$] and the open loop gain [$G_{LOOP}(f) = G_{PW0} \cdot G_{LC}(f) \cdot G_{TYPEII}(f)$] are drawn.

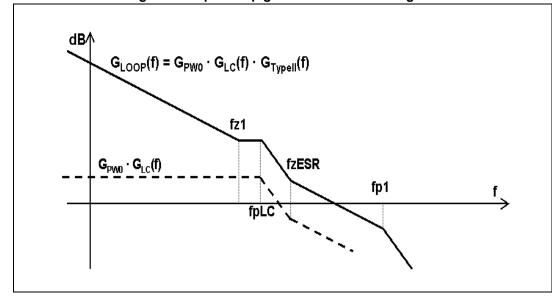


Figure 15. Open loop gain: module Bode diagram

The guidelines for positioning the poles and the zeroes and for calculating the component values can be summarized as follows:

- 1. Choose a value for R_1 , usually between 1 $k\Omega$ and 5 $k\Omega$, in order to have values of C4 and C5 not comparable with parasitic capacitance of the board.
- 2. Choose a gain (R_4/R_1) in order to have the required bandwidth (BW), that means:

Equation 27

$$\textbf{R}_{4} = \left(\frac{\textbf{f}_{ESR}}{\textbf{f}_{LC}}\right)^{2} \cdot \frac{\textbf{BW}}{\textbf{f}_{ESR}} \cdot \frac{\textbf{V}_{S}}{\textbf{V}_{IN}} \cdot \textbf{R}_{1}$$

Where f_{ESR} is the ESR zero:

Equation 28

$$f_{ESR} = \frac{1}{2\pi \cdot ESR \cdot C_{OUT}}$$

and V_S is the saw-tooth amplitude. The voltage feedforward keeps the ratio V_S/V_{IN} constant.

3. Calculate C_4 by placing the zero one decade below the output filter double pole:

Equation 29

$$C_4 = \frac{10}{2\pi \cdot R_4 \cdot f_{LC}}$$

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4. Then calculate C₃ in order to place the second pole at four times the system bandwidth (BW):

Equation 30

$$C_5 = \frac{C_4}{2\pi \cdot R_4 \cdot C_4 \cdot 4 \cdot BW - 1}$$

For example: with V_{OUT} = 3.3 V, V_{IN} = 12 V, I_O = 3 A, L = 10 μ H, C_{OUT} = 330 μ F, ESR = 35 m Ω , the type II compensation network is:

$${\rm R}_1 = 1.5 {\rm k}\Omega, \quad {\rm R}_2 = 330\Omega, \quad {\rm R}_4 = 10 {\rm k}\Omega, \quad {\rm C}_4 = 47 {\rm nF}, \quad {\rm C}_5 = 82 {\rm pF}$$



In *Figure 16* is shown the module and phase of the open loop gain. The bandwidth is about 32 kHz and the phase margin is 45°.

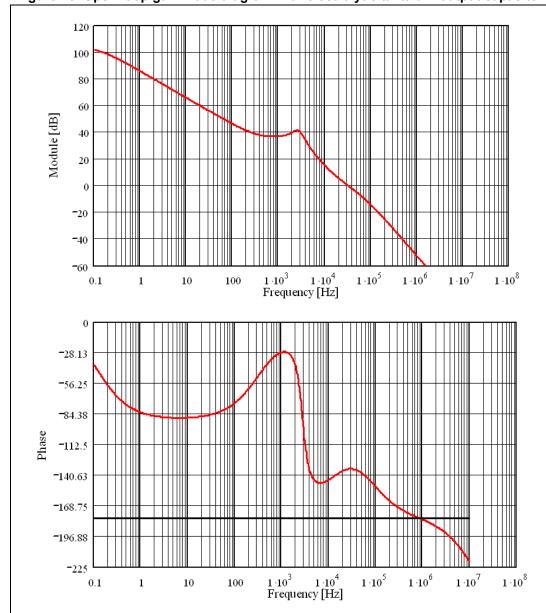


Figure 16. Open loop gain Bode diagram with electrolytic/tantalum output capacitor



6.5 Thermal considerations

The thermal design is important to prevent the thermal shutdown of the device if junction temperature goes above 150 °C. The three different sources of losses within the device are:

a) Conduction losses due to the not negligible $R_{DS(on)}$ of the power switch; these are equal to:

Equation 31

$$P_{ON} = R_{DSON} \cdot (I_{OUT})^2 \cdot D$$

Where D is the duty cycle of the application and the maximum $R_{DS(on)}$ overtemperature is 220 m Ω . Note that the duty cycle is theoretically given by the ratio between V_{OUT} and V_{IN} , but actually it is quite higher to compensate the losses of the regulator. So the conduction losses increase compared with the ideal case.

b) Switching losses due to Power MOSFET turn ON and OFF; these can be calculated as:

Equation 32

$$\mathsf{P}_{\mathsf{SW}} = \mathsf{V}_{\mathsf{IN}} \cdot \mathsf{I}_{\mathsf{OUT}} \cdot \frac{(\mathsf{T}_{\mathsf{RISE}} + \mathsf{T}_{\mathsf{FALL}})}{2} \cdot \mathsf{Fsw} = \mathsf{V}_{\mathsf{IN}} \cdot \mathsf{I}_{\mathsf{OUT}} \cdot \mathsf{T}_{\mathsf{SW}} \cdot \mathsf{F}_{\mathsf{SW}}$$

Where T_{RISE} and T_{FALL} are the overlap times of the voltage across the power switch (V_{DS}) and the current flowing into it during turn ON and turn OFF phases, as shown in *Figure 17*. T_{SW} is the equivalent switching time. For this device the typical value for the equivalent switching time is 50 ns.

c) Quiescent current losses, calculated as:

Equation 33

$$P_Q = V_{IN} \cdot I_Q$$

where I_{Q} is the quiescent current ($I_{Q} = 2.4 \text{ mA}$).

The junction temperature T_J can be calculated as:

Equation 34

$$T_J = T_A + Rth_{JA} \cdot P_{TOT}$$

Where T_A is the ambient temperature and P_{TOT} is the sum of the power losses just seen.

 R_{thJA} is the equivalent thermal resistance junction to ambient of the device; it can be calculated as the parallel of many paths of heat conduction from the junction to the ambient. For this device the path through the exposed pad is the one conducting the largest amount of heat. The Rth_{JA} measured on the demonstration board described in *Section 6.6: Layout considerations* is about 60 °C/W for the VFQFPN package and about 40 °C/W for the HSOP package.



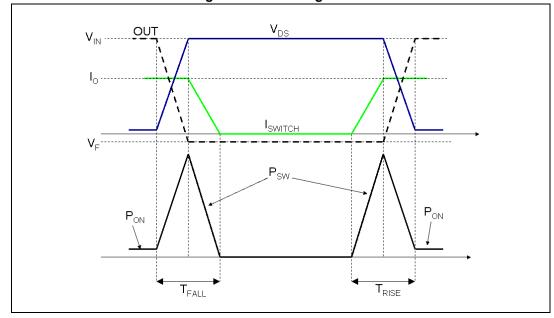


Figure 17. Switching losses

6.6 Layout considerations

The PC board layout of switching DC/DC regulator is very important to minimize the noise injected in high impedance nodes and interferences generated by the high switching current loops.

In a step-down converter the input loop (including the input capacitor, the Power MOSFET and the free wheeling diode) is the most critical one. This is due to the fact that the high value pulsed current are flowing through it. In order to minimize the EMI, this loop has to be as short as possible.

The feedback pin (FB) connection to external resistor divider is a high impedance node, so the interferences can be minimized placing the routing of the feedback node as far as possible from the high current paths. To reduce the pick up noise the resistor divider has to be placed very close to the device.

To filter the high frequency noise, a small capacitor (220 nF) can be added as close as possible to the input voltage pin of the device.

Thanks to the exposed pad of the device, the ground plane helps to reduce the thermal resistance junction to ambient; so a large ground plane enhances the thermal performance of the converter allowing high power conversion.

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In Figure 18 a layout example is shown.

OUTPUT CAPACITOR DIRECTLY CONNECTED TO HEAVY GOUND **GND** VERY SMALL HIGH CURRENT VOUT Cout CIRCULATING PATH TO MINIMIZE RADIATION AND HIGH FREQUENCY RESONANCE PROBLEMS GND VCC R2 R3 C3 MINIMUM FEEDBACK PIN SYNCH ROUTING TO AVOID PICKUP **GND** COMPENSATION NETWORK FAR GROUND PLANE CONNECTED TO EXPOSED PAD TO ENHANCE THERMAL PERFORMANCE FROM HIGH CURRENT PATHS

Figure 18. Layout example



6.7 Application circuit

In Figure 19 the demonstration board application circuit is shown.

<u>Vin=2.9V</u> - 18V L1 5.2uH MSS1038 VCC 8 Vout=1.8V OUT C1 C6 -220n 25V -22u 25V <u>INH</u> ↓ 3 22u D1 L5987/A 2 ¢ SYNCH 25V STPS2L25 GND , FSW COMP ___ R1 4.99K R5 150k R4 C4 10hF 2K \/\/-R3 ≥ R2 ≥2.49k C5 330pF C3 2.2nF 330

Figure 19. Demonstration board application circuit

Table 9. Component list

rable of compensation						
Reference	Part number	Description	Manufacturer			
C1	GRM32ER61E226KE15	22 μF, 25 V	MURATA			
C2	GRM32ER61E226KE15	22 μF, 25 V	MURATA			
C3		2.2 nF, 50 V				
C4		10 nF, 50 V				
C5		330 pF, 50 V				
C6		220 nF, 25 V				
R1		4.99 kΩ, 1%, 0.1 W 0603				
R2		2.49 kΩ, 1%, 0.1 W 0603				
R3		330 Ω, 1%, 0.1 W 0603				
R4		2 kΩ, 1%, 0.1 W 0603				
R5		100 kΩ				
D1	STPS2L25V	2 A DC, 2 5V	STMicroelectronics			
L1	MSS1038-522NL	5.2 μH, 30%, 5.28 A, DCR _{MAX} = 22 mΩ	Coilcraft			

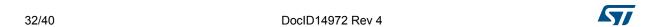
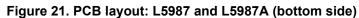


Figure 20. PCB layout: L5987 and L5987A (component side)



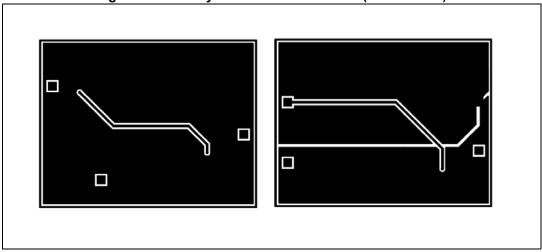


Figure 22. PCB layout: L5987 and L5987A (front side)

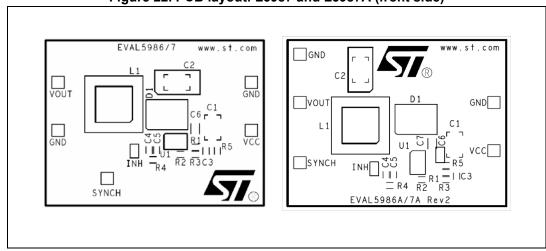
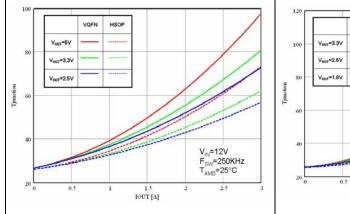




Figure 23. Junction temperature vs. output current - V_{IN} = 12 V

Figure 24. Junction temperature vs. output current - V_{IN} = 5 V

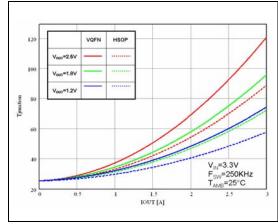


120
VOFN HSOP
Vour=3.3V
Vour=2.6V
Vour=1.6V

Vour=2.6V
T_SW=250KHz
T_AME=25°C
TOUT [A]

Figure 25. Junction temperature vs. output current - V_{IN} = 3.3 V

Figure 26. Efficiency vs. output current - V_{IN} = 12 V



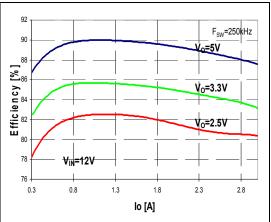
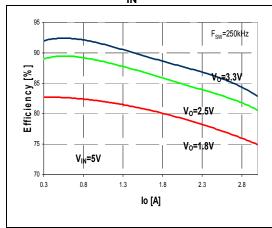
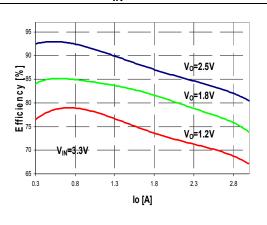


Figure 27. Efficiency vs. output current - V_{IN} = 5 V

Figure 28. Efficiency vs. output current - V_{IN} = 3.3 V





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Figure 29. Load regulation

Figure 30. Line regulation

Voc=12V

Voc=5V

Voc=5V

Voc=5V

Voc=5V

Voc=5V

Voc=5V

Voc=5V

Voc=60

Voc=6

Figure 31. Load transient: from 0.4 A to 3 A

I₀ [A]

Figure 32. Soft-start

V_{cc} [V]

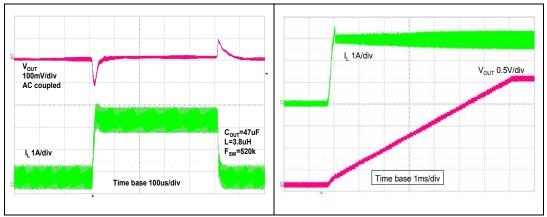
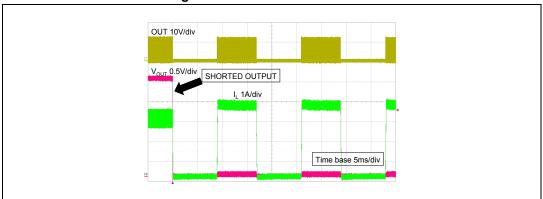


Figure 33. Short-circuit behavior





Package information L5987

7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

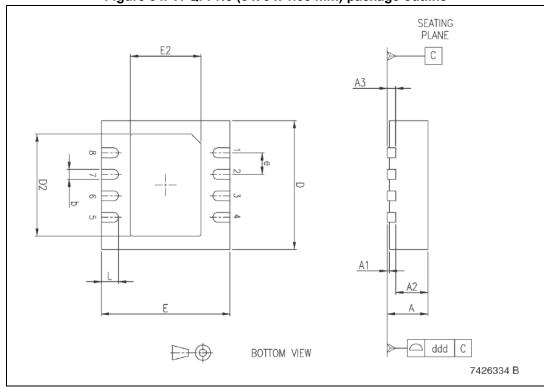


Figure 34. VFQFPN8 (3 x 3 x 1.08 mm) package outline

L5987 Package information

Table 10. VFQFPN8 (3 x 3 x 1.08 mm) package mechanical data

	Dimensions						
Symbol		mm			inch		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.80	0.90	1.00	0.0315	0.0354	0.0394	
A1		0.02	0.05		0.0008	0.0020	
A2		0.70			0.0276		
A3		0.20			0.0079		
b	0.18	0.23	0.30	0.0071	0.0091	0.0118	
D	2.95	3.00	3.05	0.1161	0.1181	0.1200	
D2	2.23	2.38	2.48	0.0878	0.0937	0.0976	
E	2.95	3.00	3.05	0.1161	0.1181	0.1200	
E2	1.65	1.70	1.75	0.0649	0.0669	0.0689	
е		0.50			0.0197		
L	0.35	0.40	0.45	0.0137	0.0157	0.0177	
ddd			0.08			0.0031	

Package information L5987

Ε Α Exposed Pad: D1 = 3.1mm E2 = 2.41mm A2 E2 A1 0 5 SEATING PLANE O E1 С 200 0,25 mm GAGE PLANE O 7195016 C

Figure 35. HSOP8 package outline

Table 11. HSOP8 package mechanical data

	Dimensions						
Symbol		mm			inch		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.70			0.0669	
A1	0.00		0.15		0.00	0.0059	
A2	1.25			0.0492			
b	0.31		0.51	0.0122		0.0201	
С	0.17		0.25	0.0067		0.0098	
D	4.80	4.90	5.00	0.1890	0.1929	0.1969	
E	5.80	6.00	6.20	0.2283		0.2441	
E1	3.80	3.90	4.00	0.1496		0.1575	
е		1.27					
h	0.25		0.50	0.0098		0.0197	
L	0.40		1.27	0.0157		0.0500	
k	0		8			0.3150	
ccc			0.10			0.0039	



L5987 Order codes

8 Order codes

Table 12. Order codes

Order codes	Package	Packaging	
L5987A	HSOP8	Tube	
L5987TR	VFQFPN8	Tape and reel	
L5987ATR	HSOP8		

9 Revision history

Table 13. Document revision history

Date	Revision	Changes
29-Aug-2008	1	Initial release
29-Jan-2009	2	Updated: Equation 22
19-Jun-2009	3	Updated Table 4 on page 6 and Figure 6 on page 10
13-May-2014	4	Numbered Equation 26 on page 25. Updated Section 7: Package information on page 36 (updated titles, reversed order of Figure 34 and Table 10, Figure 35 and Table 11, minor modifications). Updated Table 12: Order codes (removed the L5987 order code related to the VFQFPN8 in tube). Updated cross-references throughout document. Minor modifications throughout document.

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BD9S201NUX-CE2 MP5461GC-Z MPQ4415AGQB-Z MPQ4590GS-Z MAX38640BENT18+T MAX77511AEWB+